

FK18SM-12-VB Datasheet

N-Channel 600V (D-S) Super Junction MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} at 25 °C (Ω)	V _{GS} = 10 V	0.38		
Q _g max. (nC)	38			
Q _{gs} (nC)	4			
Q _{gd} (nC)	4.2			
Configuration	Single			

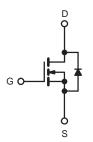
TO-3P G D (TAB)

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Q_a)
- Avalanche energy rated (UIS)

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	600	V	
Gate-Source Voltage			V_{GS}	± 30	V	
Continuous Drain Current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 25 °C	I _D	11		
		$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$		9.7	Α	
Pulsed Drain Current ^a			I _{DM}	50		
Linear Derating Factor				1.67/1.5/0.3	W/°C	
Single Pulse Avalanche Energy b			E _{AS}	132	mJ	
Maximum Power Dissipation			P_{D}	83/83/31	W	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C	
Drain-Source Voltage Slope	T _J = 125 °C		-1\//-1+	50	1//	
Reverse Diode dV/dt ^d		dV/dt	3.1	- V/ns		
Soldering Recommendations (Peak Temperature) c	for 10 s			300	°C	

- a. Repetitive rating; pulse width limited by maximum junction temperature. b. $V_{DD}=50$ V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 4.5 A.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, dI/dt = 100 A/ μ s, starting $T_J = 25$ °C.

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP. MAX.		UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	60	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	0.6	G/ VV	

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		•					•
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I _D = 1 mA		-	0.65	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$		-	4	٧
		$V_{GS} = \pm 20 \text{ V}$ $V_{GS} = \pm 30 \text{ V}$		-	-	± 100	nA
Gate-Source Leakage	I _{GSS}			-	-	± 1	μΑ
		V _{DS} =	V _{DS} = 650 V, V _{GS} = 0 V V _{DS} = 520 V, V _{GS} = 0 V, T _J = 125 °C		-	1	μΑ
Zero Gate Voltage Drain Current	I _{DSS}				-	10	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 5 A	-	0.38	-	Ω
Forward Transconductance	9fs	V _{DS} = 30 V, I _D = 5 A		-	16	-	S
Dynamic				•	•		
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 100 V, f = 1 MHz		-	680	-	pF
Output Capacitance	Coss			-	140	-	
Reverse Transfer Capacitance	C _{rss}			-	5	_	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V _{DS} = 0 V to 520 V, V _{GS} = 0 V		-	63	-	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	113	-	
Total Gate Charge	Qg			-	38	56	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 5 \text{ A}, V_{DS} = 520 \text{ V}$		-	4	-	nC
Gate-Drain Charge	Q_{gd}			-	4.5	-	1
Turn-On Delay Time	t _{d(on)}	$V_{DD} = 520 \text{ V}, I_D = 5 \text{ A}, V_{GS} = 10 \text{ V}, R_g = 9.1 \Omega$		-	13	25	ns
Rise Time	t _r			-	11	35	
Turn-Off Delay Time	t _{d(off)}			-	81	90	
Fall Time	t _f			-	25	40	
Gate Input Resistance	R_{g}	f = 1 MHz, open drain		-	3.5	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	11	
Pulsed Diode Forward Current	I _{SM}			-	-	55	Α
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 5 A, V _{GS} = 0 V		-	-	1.5	V
Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = I _S = 5 A, dl/dt = 100 A/μs, V _R = 400 V		-	270	-	ns
Reverse Recovery Charge	Q _{rr}			-	3.3	-	μC
Reverse Recovery Current	I _{RBM}			_	30	_	A

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

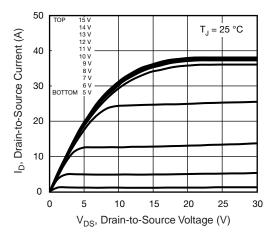


Fig. 1 - Typical Output Characteristics

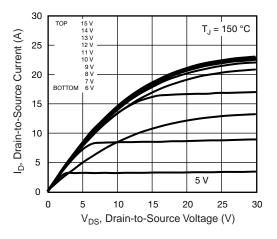


Fig. 2 - Typical Output Characteristics

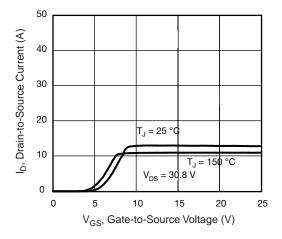


Fig. 3 - Typical Transfer Characteristics

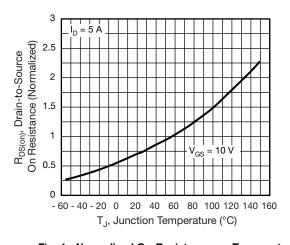


Fig. 4 - Normalized On-Resistance vs. Temperature

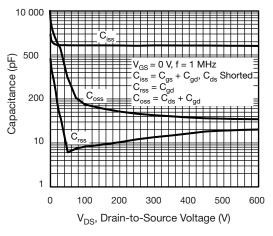


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

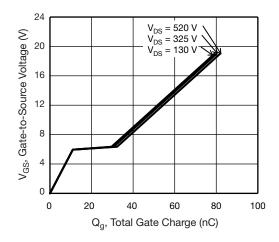


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



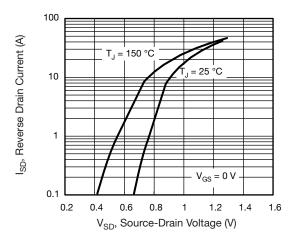


Fig. 7 - Typical Source-Drain Diode Forward Voltage

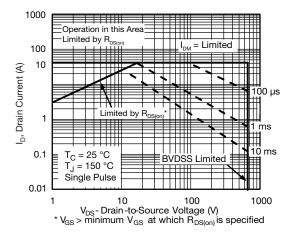


Fig. 8 - Maximum Safe Operating Area

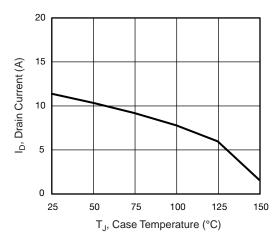


Fig. 9 - Maximum Drain Current vs. Case Temperature

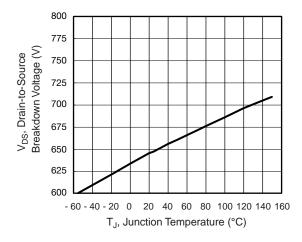


Fig. 10 - Temperature vs. Drain-to-Source Voltage

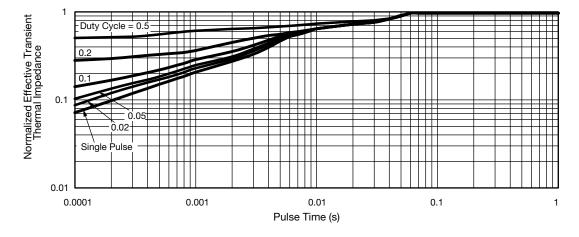


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case

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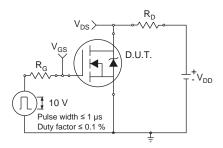


Fig. 12 - Switching Time Test Circuit

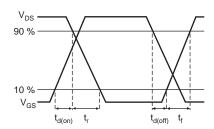


Fig. 13 - Switching Time Waveforms

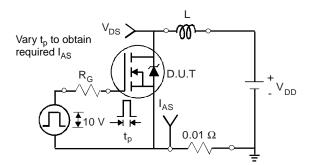


Fig. 14 - Unclamped Inductive Test Circuit

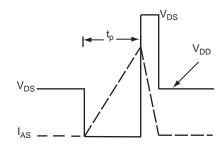


Fig. 15 - Unclamped Inductive Waveforms

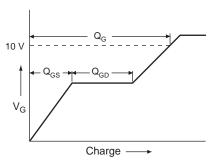


Fig. 16 - Basic Gate Charge Waveform

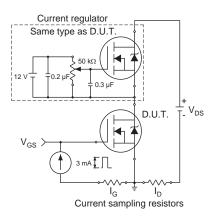
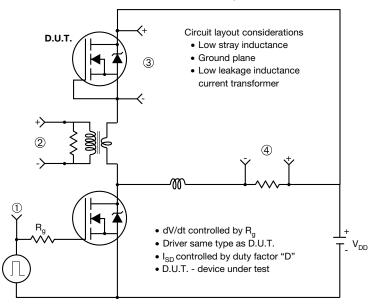


Fig. 17 - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit



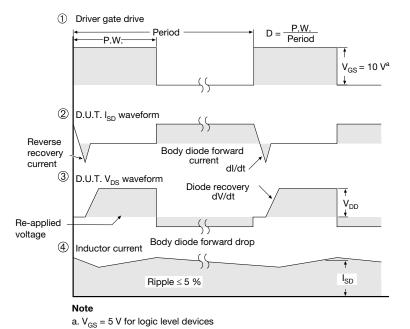
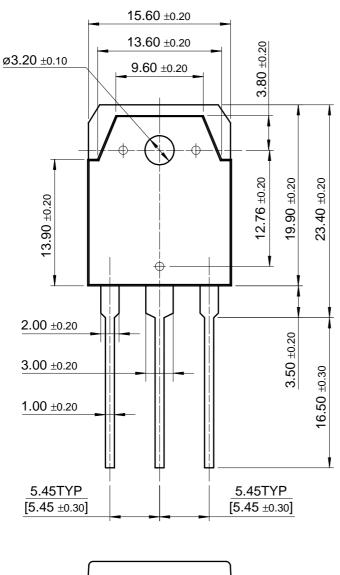


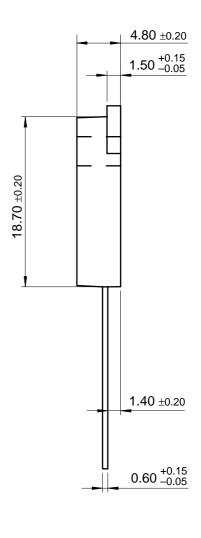
Fig. 18 - For N-Channel

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TO-3P







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